

## **PNP General Purpose Amplifier**

This device is designed for use as a general purpose amplifier and switch requiring collector currents to 500 mA.

### **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
lc	Collector Current - Continuous	600	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## Thermal Characteristics

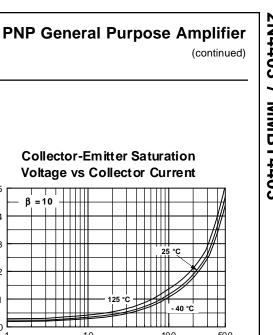
Symbol	Characteristic	Мах		Units
		2N4403	*MMBT4403	
PD	Total Device Dissipation	625	350	mW
	Derate above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

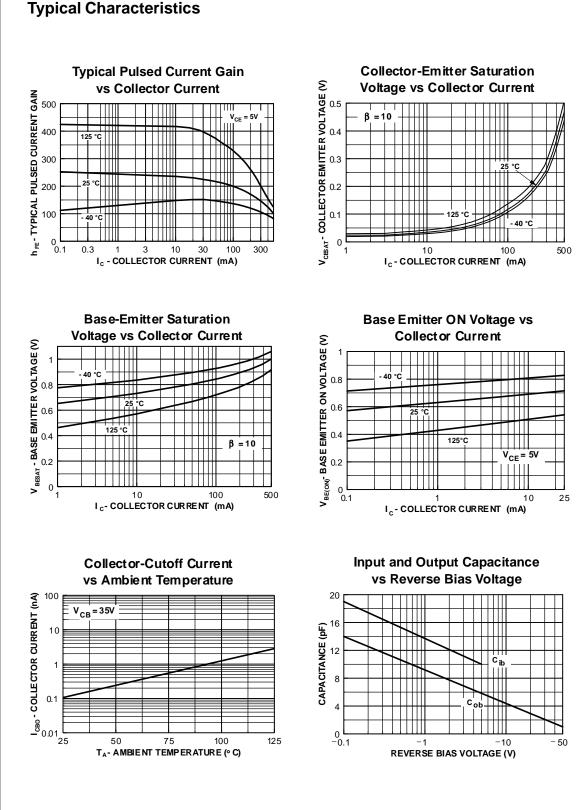
TA = 25°C unless otherwise noted

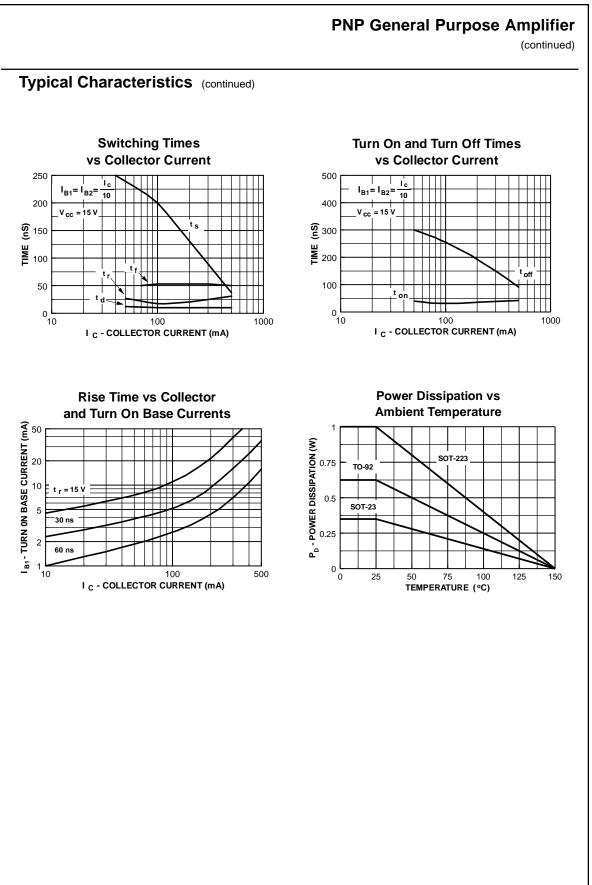
\*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

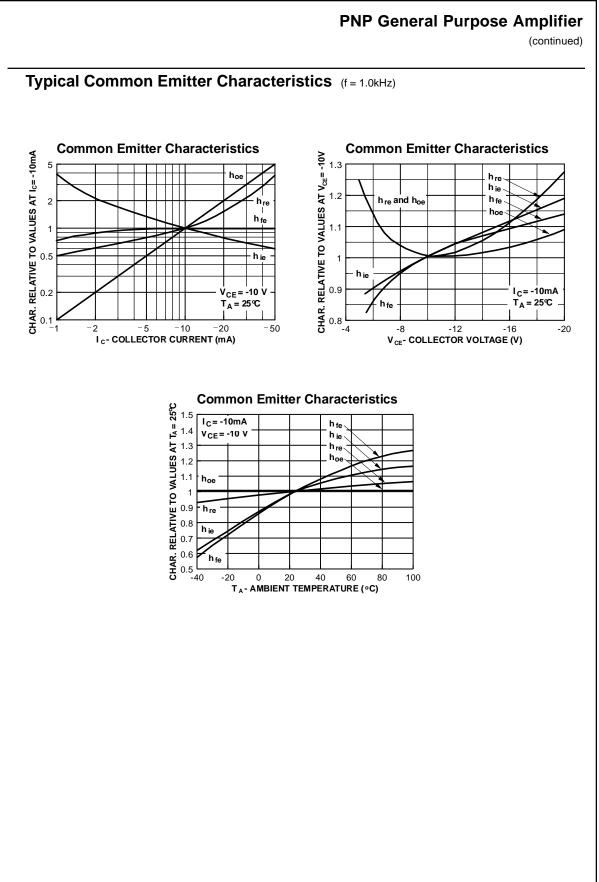
© 2001 Fairchild Semiconductor Corporation

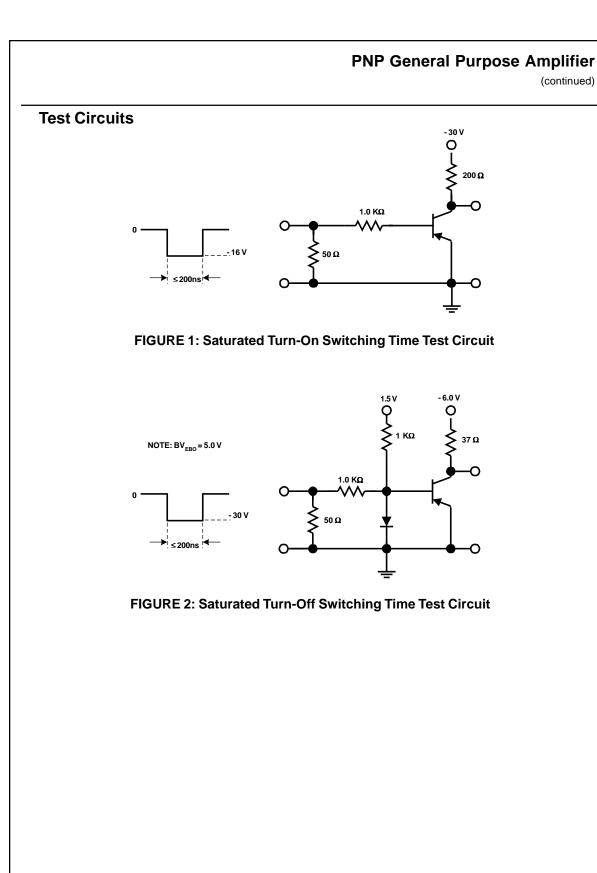
					(continu
Electr	ical Characteristics	= 25°C unless otherwise noted		1	
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage*	$I_{\rm C} = 1.0 \text{ mA}, I_{\rm B} = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{\rm C} = 0.1 \text{ mA}, I_{\rm E} = 0$	40	-	V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_{\rm E} = 0.1 \text{ A}, I_{\rm C} = 0$	5.0	-	V
I <sub>BEX</sub>	Base Cutoff Current	V <sub>CE</sub> = 35 V, V <sub>EB</sub> = 0.4 V		0.1	μA
I <sub>CEX</sub>	Collector Cutoff Current	$V_{CE} = 35 \text{ V}, \text{ V}_{BE} = 0.4 \text{ V}$		0.1	μA
ON CHAR	ACTERISTICS DC Current Gain	$I_{C} = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_{C} = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_{C} = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_{C} = 150 \text{ mA}, V_{CE} = 2.0 \text{ V}^{*}$	30 60 100 100	300	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage*	$\label{eq:lc} \begin{array}{l} I_{C} = 500 \text{ mA},  \text{V}_{CE} = 2.0  \text{V}^{*} \\ I_{C} = 150 \text{ mA},  \text{I}_{B} = 15 \text{ mA} \\ I_{C} = 500 \text{ mA},  \text{I}_{B} = 50 \text{ mA} \end{array}$	20	0.4 0.75	V V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_{C} = 500 \text{ mA}, I_{B} = 50 \text{ mA}$ $I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}^{*}$ $I_{C} = 500 \text{ mA}, I_{B} = 50 \text{ mA}$	0.75	0.95	V V
SMALL SI	GNAL CHARACTERISTICS	$I_{C} = 20 \text{ mA}, V_{CE} = 10 \text{ V},$	200	<u></u>	MHz
C <sub>cb</sub>	Collector-Base Capacitance	$\begin{array}{l} f = 100 \text{ MHz} \\ V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \\ f = 140 \text{ kHz} \end{array}$		8.5	pF
C <sub>eb</sub>	Emitter-Base Capacitance	$V_{BE} = 0.5 V, I_C = 0,$ f = 140 kHz		30	pF
h <sub>ie</sub>	Input Impedance	$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 1.0 kHz	1.5	15	kΩ
h <sub>re</sub>	Voltage Feedback Ratio	$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	0.1	8.0	x 10 <sup>-</sup>
h <sub>fe</sub>	Small-Signal Current Gain	$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	60	500	
h <sub>oe</sub>	Output Admittance	$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	1.0	100	μmho
SWITCHI	NG CHARACTERISTICS				
t <sub>d</sub>	Delay Time	$V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA},$		15	ns
tr	Rise Time	I <sub>B1</sub> = 15 mA		20	ns
	Storage Time	$V_{CC} = 30 \text{ V}, \text{ I}_{C} = 150 \text{ mA}$		225	ns
ts	g				











### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx<sup>TM</sup> Bottomless<sup>TM</sup> CoolFET<sup>TM</sup> CROSSVOLT<sup>TM</sup> DenseTrench<sup>TM</sup> DOME<sup>TM</sup> EcoSPARK<sup>TM</sup> E<sup>2</sup>CMOS<sup>TM</sup> EnSigna<sup>TM</sup> FACT<sup>TM</sup> FACT Quiet Series<sup>TM</sup> FAST $^{\textcircled{(0)}}$ OPTOLFASTr<sup>TM</sup>OPTOFFRFET<sup>TM</sup>PACMAGlobalOptoisolator<sup>TM</sup>POPTMGTO<sup>TM</sup>Power2HiSeC<sup>TM</sup>Power7ISOPLANAR<sup>TM</sup>QFETTMLittleFET<sup>TM</sup>QS<sup>TM</sup>MicroFET<sup>TM</sup>QT OptMicroPak<sup>TM</sup>Quiet SMICROWIRE<sup>TM</sup>SILENT

OPTOLOGIC<sup>™</sup> OPTOPLANAR<sup>™</sup> PACMAN<sup>™</sup> POP<sup>™</sup> Power247<sup>™</sup> PowerTrench<sup>®</sup> QFET<sup>™</sup> QS<sup>™</sup> QT Optoelectronics<sup>™</sup> Quiet Series<sup>™</sup> SILENT SWITCHER<sup>®</sup> SMART STARTTMVCXTMSTAR\*POWERTMStealthTMSuperSOTTM-3SuperSOTTM-6SuperSOTTM-6SuperSOTTM-8SyncFETTMTinyLogicTMTruTranslationTMUHCTMUHCTMUltraFET®

STAR\*POWER is used under license

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.